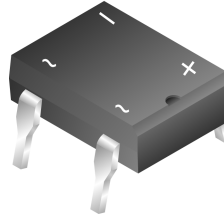


## DF005M - DF10M

### Features

- Surge overload rating: 50 amperes peak.
- Glass passivated junction.
- Low leakage.
- UL certified, UL #E111753.



DIP

## 1.5 Ampere Bridge Rectifiers

### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value	Units
$I_{F(AV)}$	Average Rectified Current @ $T_A = 40^\circ\text{C}$	1.5	A
$I_{FSM}$	Non-repetitive Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	50	A
$P_D$	Total Device Dissipation Derate above $25^\circ\text{C}$	3.1 25	W mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,** per leg	40	$^\circ\text{C}/\text{W}$
$T_{stg}$	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

\*\*Device mounted on PCB with 0.5 x 0.5" (13 x 13 mm).

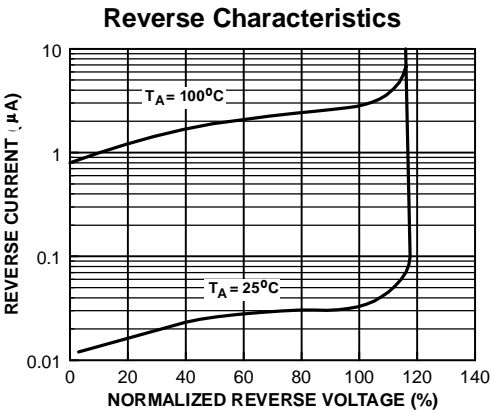
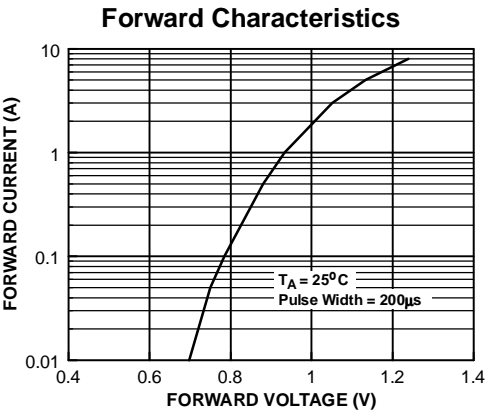
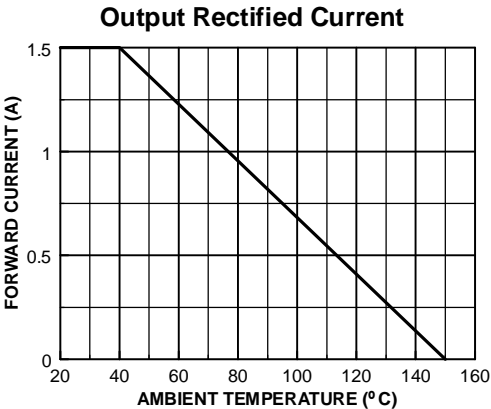
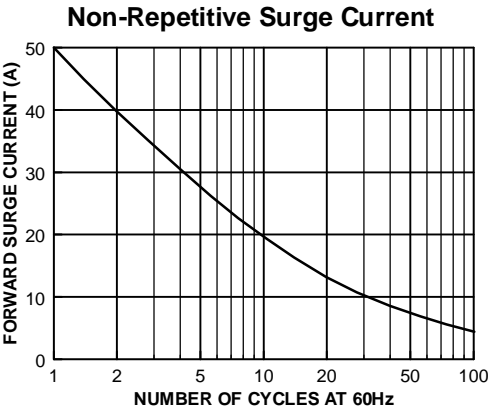
### Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Device							Units
		005M	01M	02M	04M	06M	08M	10M	
V <sub>RRM</sub>	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
V <sub>RMS</sub>	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
V <sub>R</sub>	DC Reverse Voltage (Rated V <sub>R</sub> )	50	100	200	400	600	800	1000	V
I <sub>RM</sub>	Maximum Instantaneous Reverse Leakage, total bridge @ rated V <sub>R</sub> T <sub>A</sub> = 25°C T <sub>A</sub> = 125°C	5.0 500							μA μA
V <sub>FM</sub>	Maximum Instantaneous Forward Voltage Drop, per bridge @ 1.0 A	1.1							V
	I <sup>2</sup> t rating for fusing t < 8.35 ms	10							A <sup>2</sup> s
C	Typical Junction Capacitance, per leg V <sub>R</sub> = 4.0 V, f = 1.0 MHz	25							pF

Bridge Rectifiers  
(continued)

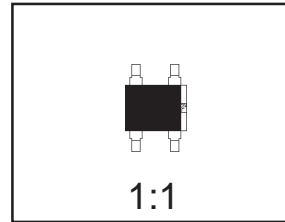
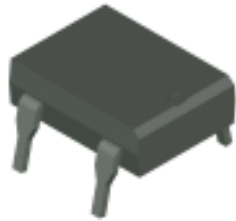
Typical Characteristics



## DIP Package Dimensions



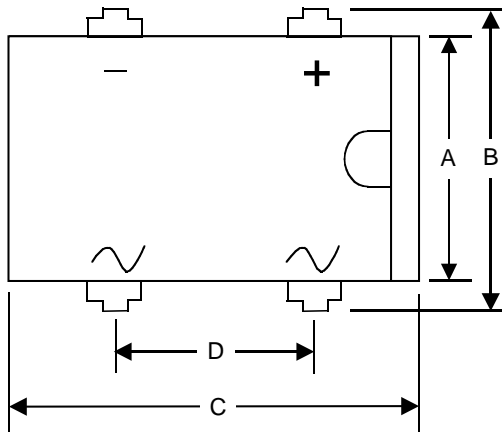
### DIP (FS PKG Code R3)



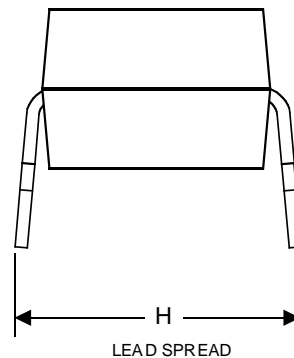
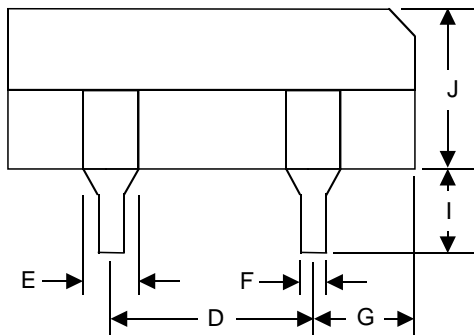
Scale 1:1 on letter size paper

Dimensions shown below are in:  
inches [millimeters]

Part Weight per unit (gram): 0.4



DIM	MIN (in)	MAX (in)	MIN (mm)	MAX (mm)
A	.245	.255	6.223	6.477
B	.285	.315	7.239	8.001
C	.320	.335	8.128	8.509
D	.195	.205	4.953	5.207
E	.035	.045	0.889	1.143
F	.018	.022	0.457	0.559
G	.055	.075	1.397	1.905
H	.300	.350	7.620	8.890
I	.150	.185	3.810	4.699
J	.120	.130	3.048	3.302



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DOME™	ISOPLANAR™	Quiet Series™	
E <sup>2</sup> CMOS™	MICROWIRE™	SILENT SWITCHER®	
EnSigna™	OPTOLOGIC™	SMART START™	
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